

SOD-123FL Plastic-Encapsulate Diodes

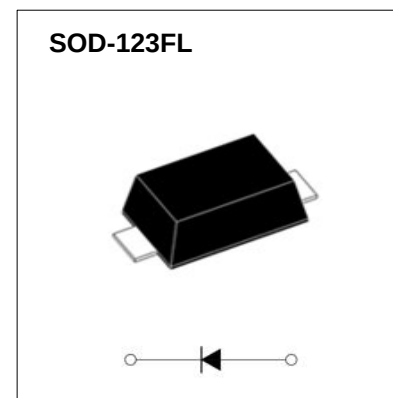
General Purpose Rectifier

Features

- I_o 1A
- V_{RRM} 50V-1000V
- Low forward voltage drop
- High surge current capability
- Glass passivated chip junction

Mechical Data

- Case: SOD-123FL molded plastic
- Molding compound: UL flammability classification rating 94V-0
- Terminals: Solder plated, solderable per MIL- STD-202, Method 208
- Polarity: Color band denotes cathode end



Limiting Values (Absolute Maximum Rating)

Item	Symbol	Unit	Conditions	S07						
				A	B	D	G	J	K	M
Repetitive Peak Reverse Voltage	V _{RRM}	V		50	100	200	400	600	800	1000
Maximum RMS Voltage	V _{RMS}	V		35	70	140	280	420	560	700
Maximum DC Blocking Voltage	V _{DC}	V		50	100	200	400	600	800	1000
Average Forward Current	I _{F(AV)}	A	60Hz Half-sine wave, Resistance load, TL=120℃	1						
Surge(Non-repetitive)Forward Current	I _{FSM}	A	60Hz Half-sine wave,1 cycle, Ta=25℃	30						
Junction Temperature	T _J	℃		-55~+150						
Storage Temperature	T _{STG}	℃		-55 ~ +150						

Electrical Characteristics ($T_a=25^{\circ}C$ Unless otherwise specified)

Item	Symbol	Unit	Test Condition		Max
Peak Forward Voltage	V _{FM}	V	I _{FM} =1.0A		1.0
Peak Reverse Current	I _{RRM1}	μA	V _{RM} =V _{RRM}	T _a =25°C	5
	I _{RRM2}			T _a =125°C	50
Reverse Recovery Time (Typical)	T _{rr}	us	I _F =0.5A I _R =1A I _{RR} =0.25A		2.5
Juction Capacitance (Typical)	C _j	pF	Measured at 1MHZ and Applied Reverse Voltage of 4.0 V.D.C.		7
Thermal Resistance (Typical)	R _{θJA}	°C/W	Between junction and ambient		85
	R _{θJL}		Between junction and lead		23
	R _{θJC}		Between junction and case		15

Typical Characteristics

FIG.1: FORWARD CURRENT DERATING CURVE

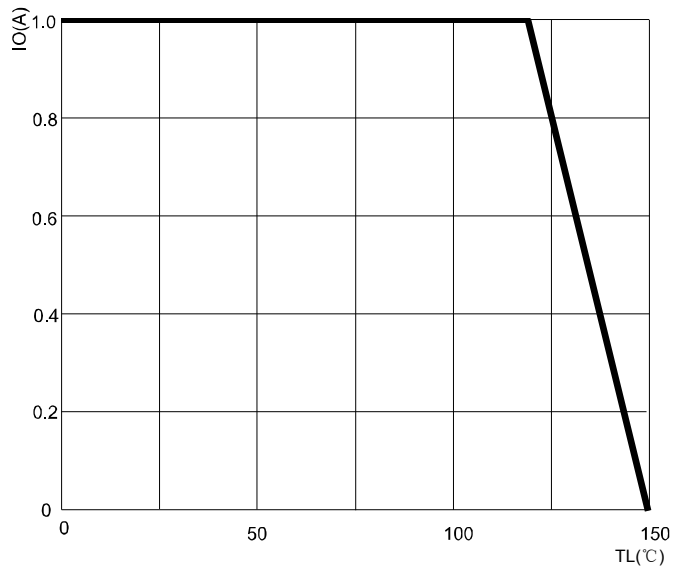


FIG.2: MAXIMUM NON-REPETITIVE FORWARD SURGE CURRENT

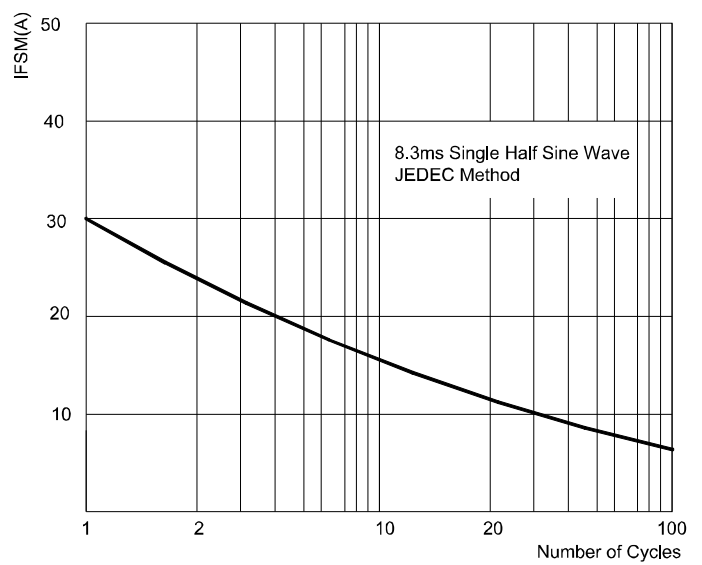


FIG.3: TYPICAL FORWARD CHARACTERISTICS

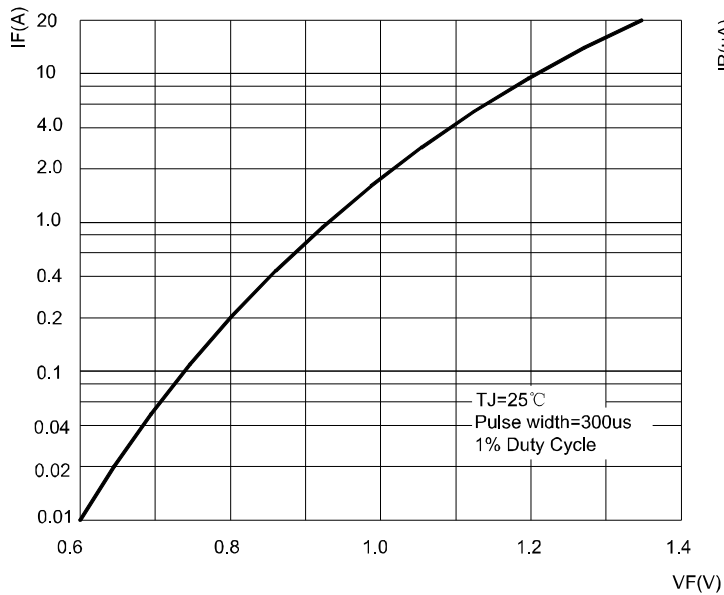
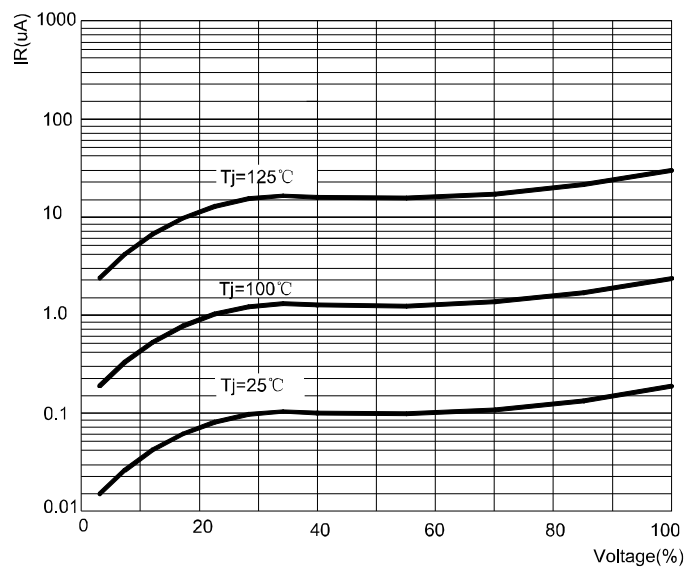
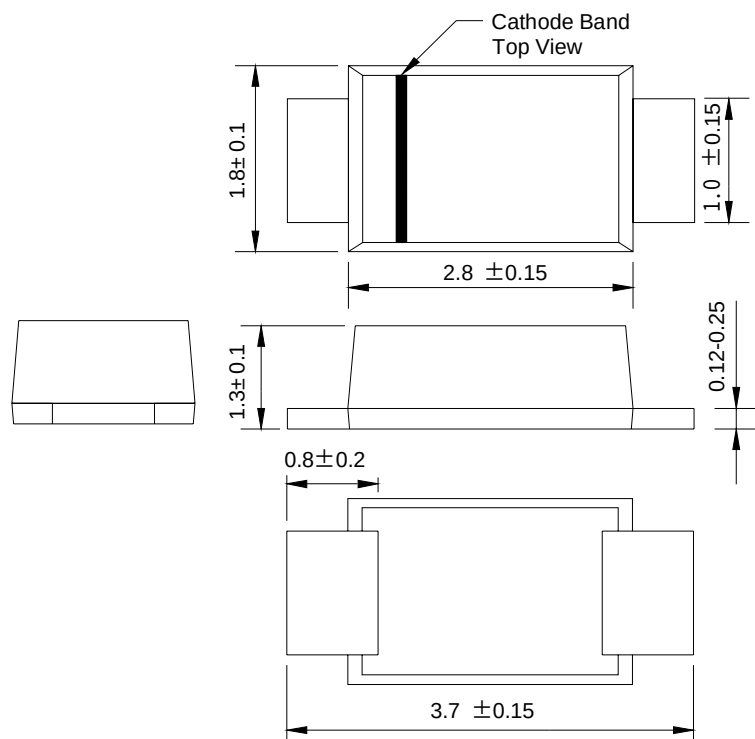


FIG.4: TYPICAL REVERSE CHARACTERISTICS

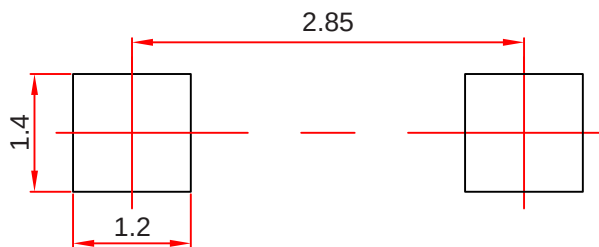


SOD-123FL Package Outline Dimensions



Dimensions in millimeters

SOD-123FL Suggested Pad Layout



- Note:**
- 1. Controlling dimension: in millimeters.
 - 2. General tolerance: ± 0.05 mm.
 - 3. The pad layout is for reference purposes only.

Ordering Information

Part Number	Package	Shipping Quantity
S07A-S07M	SOD-123FL	3000/tape&Reel

Marking Diagram



X: From 1 To 7

Reel Taping Specifications For Surface Mount Devices–SOD-123FL

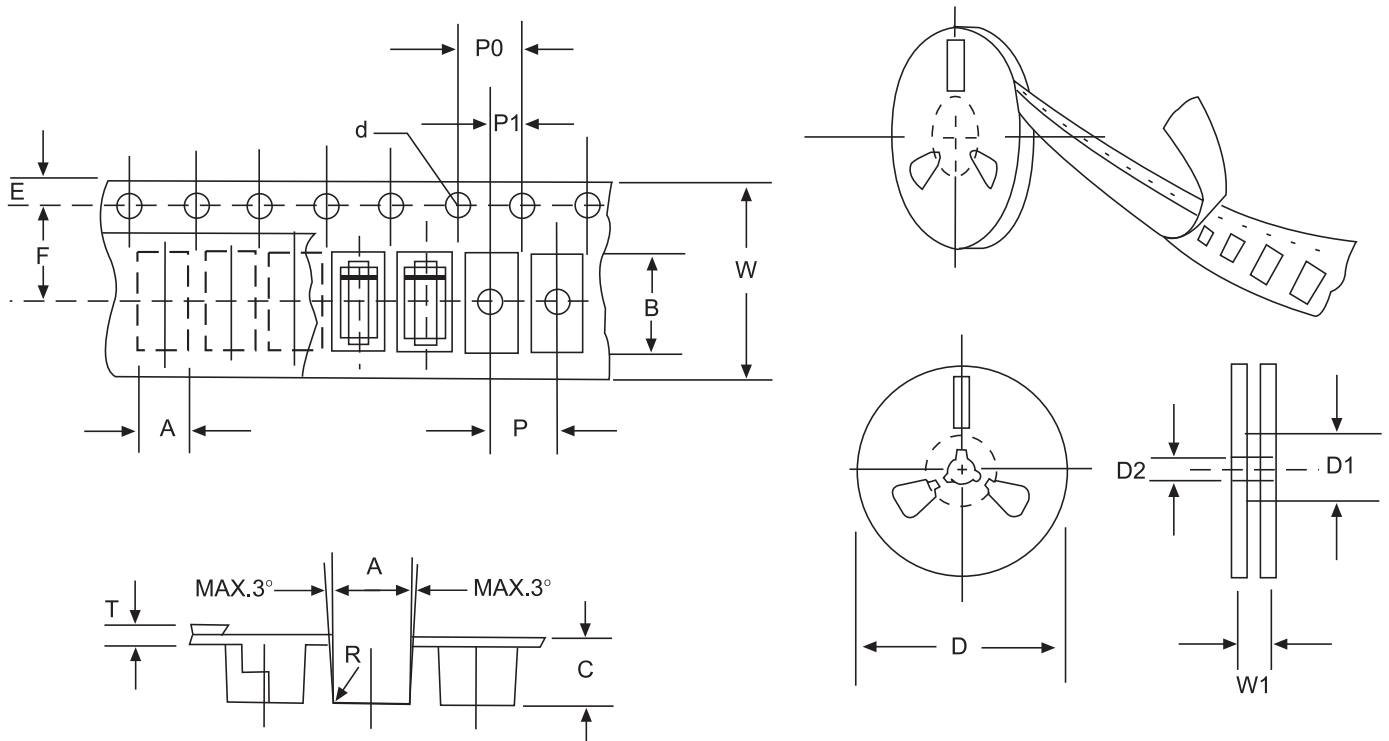


FIG: CONFIGURATION OF SURFACE MOUNTED DEVICES TAPING

ITEM	SYMBOL	SOD-123FLmm(inch)
Carrier width	A	2.05±0.1(0.081±0.004)
Carrier length	B	3.95±0.1(0.156±0.004)
Carrier depth	C	1.45±0.1(0.057±0.004)
Sprocket hole	d	1.55±0.05(0.061±0.002)
Reel outside diameter	D	178±2.0(7.0±0.079)
Reel inner diameter	D1	54±1.0(2.13±0.039)
Feed hole diameter	D2	13±0.5(0.512±0.020)
Sprocket hole position	E	1.75±0.1(0.069±0.004)
Punch hole position	F	3.50±0.1(0.138±0.002)
Punch hole pitch	P	4.0±0.1(0.157±0.004)
Sprocket hole pitch	P0	4.0±0.1(0.157±0.004)
Embossment center	P1	2.0±0.1(0.079±0.004)
Total tape thickness	T	0.21±0.25(0.008±0.010)
Tape width	W	8.0±0.2(0.315±0.008)
Reel width	W1	10.0±2.0(0.394±0.079)

NOTE: Devices are packed in accordance with EIA standard RS-481-A and specification given above.